

# A HIGH SPEED SCALAR MULTIPLIER FOR BINARY EDWARDS CURVES.

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# OUTLINE

- Elliptic Curve for Cryptography and Edwards Curves
- Motivation
- Proposed Concept
- Proposed Design Approach – Parallelism
- Employed Algorithms
- Proposed Architecture
- Results- Comparisons

# ELLIPTIC CURVE FOR CRYPTOGRAPHY

- Scalar Multiplication main crypto-operation
- Elliptic Curves described in various forms:
  - Weierstrass form (most popular, standardized NIST)
  - Hessian form
  - Montgomery form
  - Edwards form
  - ....
- Popular Elliptic Curves (EC) defined over:
  - Prime Fields  $GF(p)$ :  
Efficient software implementations
  - Binary Extension Fields  $GF(2^k)$ :  
Efficient hardware implementations

# ELLIPTIC CURVE ARITHMETIC

**Point Addition:** add two points of the Elliptic Curve to get a third point of the Elliptic Curve  $P_3 = (x_3, y_3) = P_1 + P_2$

**Point Doubling:** add one Elliptic Curve point with itself  $P_3 = 2P_1$

**Scalar Multiplication :** add one Elliptic Point with itself  $e$  times  
 $Q = e \cdot P$

- Can be analyzed in a series of point additions and point doublings

**Point operations rely on  $GF(2^k)$  operations:**

- $GF(2^k)$  multiplication and inversion: computationally demanding
- Exchange  $GF(2^k)$  inversion with several multiplications to reduce computation cost by transforming point coordinates from the affine to the projective space

# EDWARDS CURVES VS WEIERSTRASS CURVES

- Weierstrass EC equation do not provide unified symmetric approach for Point addition and Doubling. There are exception points (eg point at Infinity).
  - Problem: Exception points can be exploited for side channel and fault injection analysis attacks !!
- Weierstrass ECs are not complete. The Group law for point addition is different than the one for Point doubling.
- Edwards ECs have a unified, symmetric group law. The same equations can be used for point addition and for point doubling
- Edwards ECs have no exception points. There are complete.
- Unified Group Law + No exception Points = Edwards ECs intrinsically resistant against simple side channel attacks
- A point operation in Edwards Curves needs more  $GF(2^k)$  operations than in Weierstrass Curves

# DESIGN APPROACHES AND MOTIVATION

In Edwards curve projective coordinates, 2  $GF(2^k)$  inversions (I) are exchanged with 13 Multiplications (M) for point addition (PA).

PA Total cost: **18M**+3S+6D+24A (*higher cost than PA in Weierstrass ECs*)

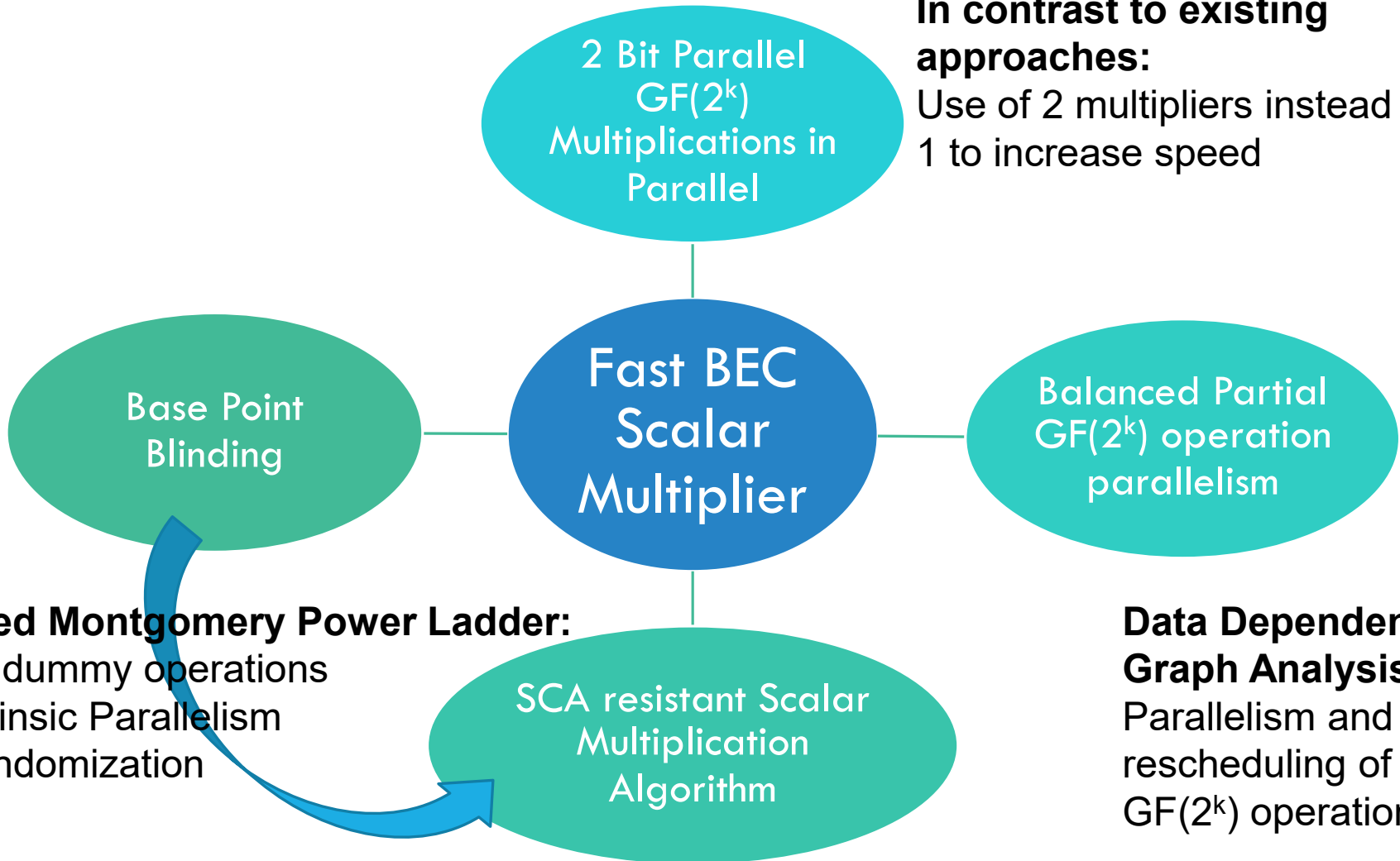
$GF(2^k)$  multiplication approaches:

- Bit Serial multipliers: slow but small number of gates and flexible (can be reused for various curves and  $GF(2^k)$ )
- Bit parallel multipliers: Fast but high number of gates and not flexible.
- Digit Serial multipliers: A compromise between bit serial and bit parallel approach

Can we design an Edwards curve scalar multiplier with similar performance characteristics as Weierstrass curve designs?

WHY: BECs offer a solid base for strong Side Channel Attack Resistance.

# PROPOSED SOLUTION CONCEPT



**In contrast to existing approaches:**  
Use of 2 multipliers instead of 1 to increase speed

**Data Dependency Graph Analysis:**  
Parallelism and rescheduling of  $GF(2^k)$  operations

## **Blinded Montgomery Power Ladder:**

- No dummy operations
- Intrinsic Parallelism
- Randomization

# BLINDED MONTGOMERY POWER LADDER

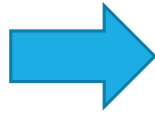
## Algorithm 2. SPA resistant MPL algorithm

**Input:**  $P$  : BEC base point  $\in EC(GF(2^k))$ ,

$e = (e_{t-1}, e_{t-2}, \dots, e_0) \in GF(2^k)$

**Output:**  $e \cdot P$

1.  $R_0 = \mathcal{O}, R_1 = P$
2. For  $i = t - 1$  to 0
  - If  $(e_i = 0)$  then
    - (a)  $R_1 = R_0 + R_1, R_0 = 2 \cdot R_0$
    - else
    - (b)  $R_0 = R_0 + R_1, R_1 = 2 \cdot R_1$
  - end if
3. Return  $R_0$



## Algorithm 3. Blinded MPL (bMPL) algorithm

**Input:**  $P$  : BEC base point, random points

$R, -R \in EC(GF(2^k)), e = (e_{t-1}, e_{t-2}, \dots, e_0) \in GF(2^k)$

**Output:**  $e \cdot P$

1.  $R_0 = R, R_1 = R + P, R_R = -R,$
2. For  $i = t - 1$  to 0
  - (a)  $R_R = 2R_R$
  - If  $(e_i = 0)$  then
    - (b)  $R_1 = R_0 + R_1, R_0 = 2 \cdot R_0$
    - else
    - (c)  $R_0 = R_0 + R_1, R_1 = 2 \cdot R_1$
  - end if
3. Return  $R_0 + R_R$

2 PD

1 PA

In parallel  
each round



# STEP 1: BREAK PA AND PD INTO SINGLE GF(2<sup>K</sup>) OPERATIONS

PA: 19 M + 2 S + 22 A

PD: 4 M + 6 S + 9 A

$(X_{3D} : Y_{3D} : Z_{3D}) = 2(X_1 : Y_1 : Z_1)$
$DA = X_1^2$ $DC = Y_1^2$ $DE = Z_1^2$ $DB = DA^2$ $DD = DC^2$ $DF1 = DE^2$ $DH = DA \cdot DE$ $DI = DC \cdot DE$ $DF = d_1 \cdot DF1$ $DG = DB + DD$ $DV2 = DH + DD$ $DV3 = DI + DB$ $DJ = DH + DI$ $DV1 = DF + DG$ $DK1 = d_2 \cdot DJ$ $DK = DG + DK1$ $Z_{3D} = DV1 + DJ$ $X_{3D} = DK + DV2$ $Y_{3D} = DK + DV3$

$(X_3 : Y_3 : Z_3) = (X_1 : Y_1 : Z_1) + (X_2 : Y_2 : Z_2)$	
$A = X_1 \cdot Y_1$ $B = Y_1 \cdot Y_2$ $C = Z_1 \cdot Z_2$ $D = d_1 \cdot C$ $E = C^2$ $F = D^2$ $G1 = X_1 + Z_1$ $G2 = X_2 + Z_2$ $H1 = Y_1 + Z_1$ $H2 = Y_2 + Z_2$ $G = G1 \cdot G2$ $H = H1 \cdot H2$ $I = A + G$ $J = B + H$ $K1 = X_1 + Y_1$ $K2 = X_2 + Y_2$ $K = K1 \cdot K2$ $L = d_1 \cdot K$ $U1 = K + I$ $U2 = J + C$ $U3 = U1 + U2$ $L1 = L \cdot U3$	$V1 = A \cdot B$ $L2 = L1 + F$ $Z3 = C \cdot L2$ $V2 = G \cdot H$ $V3 = d_1 \cdot E$ $V4 = V1 + V2$ $V5 = V3 + V4$ $L3 = L \cdot V5$ $V6 = D \cdot F$ $V7 = L3 + V6$ $V = V7 + U$ $S1 = A + D$ $S2 = G + D$ $S3 = S1 \cdot S2$ $S4 = D \cdot S3$ $X3 = V + S4$ $T1 = B + D$ $T2 = H + D$ $T3 = T1 \cdot T2$ $T4 = D \cdot T3$ $Y3 = V + T4$

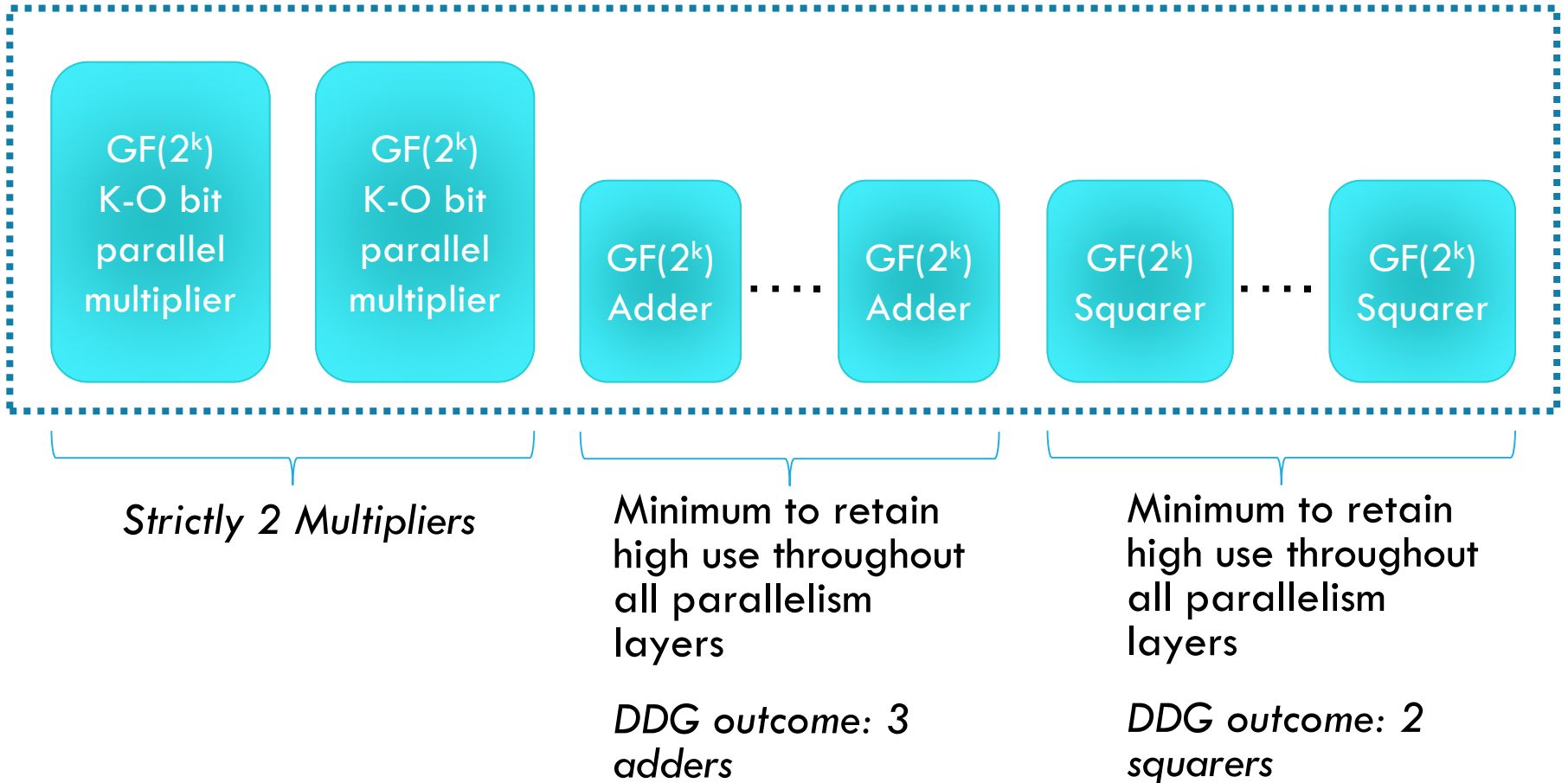
**Binary Edwards**

**EC equation:**

$$d_1(x + y) + d_2(x^2 + y^2) = xy + xy(x + y) + x^2y^2$$

# STEP 2: PARALLELISM SCHEME DDG ANALYSIS

One parallelism layer (all operations performed in parallel)



# DATA DEPENDENCY GRAPH ANALYSIS

## (CONSTRAINED FOR 2 GF(2<sup>k</sup>) MULTIPLIERS PER LAYER)

One bMPL round:

2PD and 1 PA:

Needed GF(2<sup>k</sup>) operations per round:

27 M + 14 S + 40 A

Parallelism layer dictated by M (2 per layer) →

$\left\lceil \frac{27}{2} \right\rceil$  layers + 1 final layer

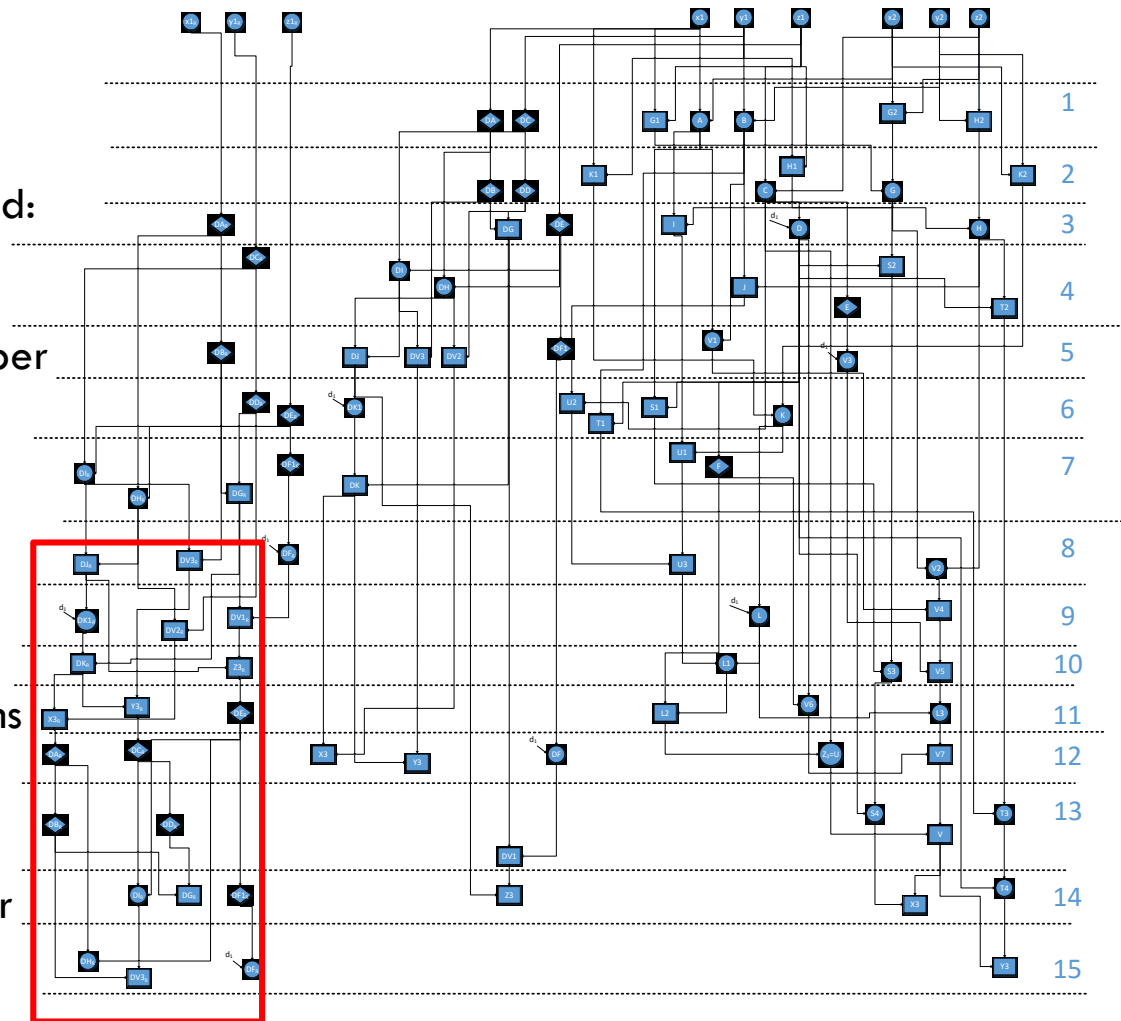
i.e. 15 layers

Assuming 3 adders and 2 squarers per layers:

**Available** 45 A and 30 S operations per round.

**Needed** 40 A and 14 S.

The unused operations employed for precomputing next round's PD



# PROPOSED PARALLELISM

1<sup>st</sup> bMPL round

Input		$(X_1 : Y_1 : Z_1)$		$(X_2 : Y_2 : Z_2)$		$(X_0 : Y_0 : Z_0)$	
layer	M1	M2	Sq1	Sq2	Ad1	Ad2	Ad3
1	A	B	DA	DC	G1	G2	H2
2	C	G	DB	DD	H1	K2	K1
3	D	H	DE	DA <sub>R</sub>	I	DG	*
4	DI	DH	DC <sub>R</sub>	E	J	S2	T2
5	V1	V3	DF1	DB <sub>R</sub>	DJ	DV2	DV3
6	DK1	K	DE <sub>R</sub>	DD <sub>R</sub>	S1	T1	U2
7	DI <sub>R</sub>	DH <sub>R</sub>	DF1 <sub>R</sub>	F	U1	DG1 <sub>R</sub>	DK
8	V2	DF <sub>R</sub>	*	*	DJ <sub>R</sub>	DV3 <sub>R</sub>	U3
9	L	DK1 <sub>R</sub>	*	*	DV2 <sub>R</sub>	DV1 <sub>R</sub>	V4
10	S3	L1	*	*	DK <sub>R</sub>	Z <sub>R</sub>	V5
11	L3	V6	DE' <sub>R</sub>	*	X <sub>R</sub>	Y <sub>R</sub>	L2
12	DF	Z3	DA <sub>R</sub>	DC' <sub>R</sub>	X3D	Y3D	V7
13	T3	S4	DB <sub>R</sub>	DD <sub>R</sub>	V	DV1	*
14	T4	DI <sub>R</sub>	DF1 <sub>R</sub>	*	X3	Z3D	DG' <sub>R</sub>
15	DH' <sub>R</sub>	DF <sub>R</sub>	*	*	Y3	DV3' <sub>R</sub>	*
Out	$(X_3 : Y_3 : Z_3)$		$(X_{3D} : Y_{3D} : Z_{3D})$		$(X_R : Y_R : Z_R)$		

Precomputing operations for next round's R<sub>R</sub> PD, reduces remaining rounds layers to 14

Remaining bMPL rounds

Inputs		$(X_1 : Y_1 : Z_1)$		$(X_2 : Y_2 : Z_2)$		$(X_0 : Y_0 : Z_0)$	
layer	M1	M2	Sq1	Sq2	Ad1	Ad2	Ad3
1	A	B	DA	DC	G1	G2	H2
2	C	G	DB	DD	H1	K2	K1
3	D	H	DE	*	I	DG	DV1 <sub>R</sub>
4	DI	DH	E	*	J	S2	T2
5	V1	V3	DF1	*	DJ	DV2	DJ <sub>R</sub>
6	DK1 <sub>R</sub>	K	*	*	S1	DV2 <sub>R</sub>	U2
7	DK1	V2	*	F	U1	DK <sub>R</sub>	T1
8	L	DF	*	*	Z <sub>R</sub>	V4	U3
9	S3	L1	DE' <sub>R</sub>	*	X <sub>R</sub>	Y <sub>R</sub>	V5
10	V6	L3	DA <sub>R</sub>	DC' <sub>R</sub>	DK	DV3	L3
11	T3	Z3	DB <sub>R</sub>	DD <sub>R</sub>	DV1	Y3D	V7
12	T4	S4	DF1 <sub>R</sub>	*	X3D	Z3D	V
13	DF <sub>R</sub>	DI <sub>R</sub>	*	*	X3	Y3	DG' <sub>R</sub>
14	DH <sub>R</sub>	*	*	*	*	DV3 <sub>R</sub>	*
Out	$(X_3 : Y_3 : Z_3)$		$(X_{3D} : Y_{3D} : Z_{3D})$		$(X_R : Y_R : Z_R)$		

\* : dummy operation

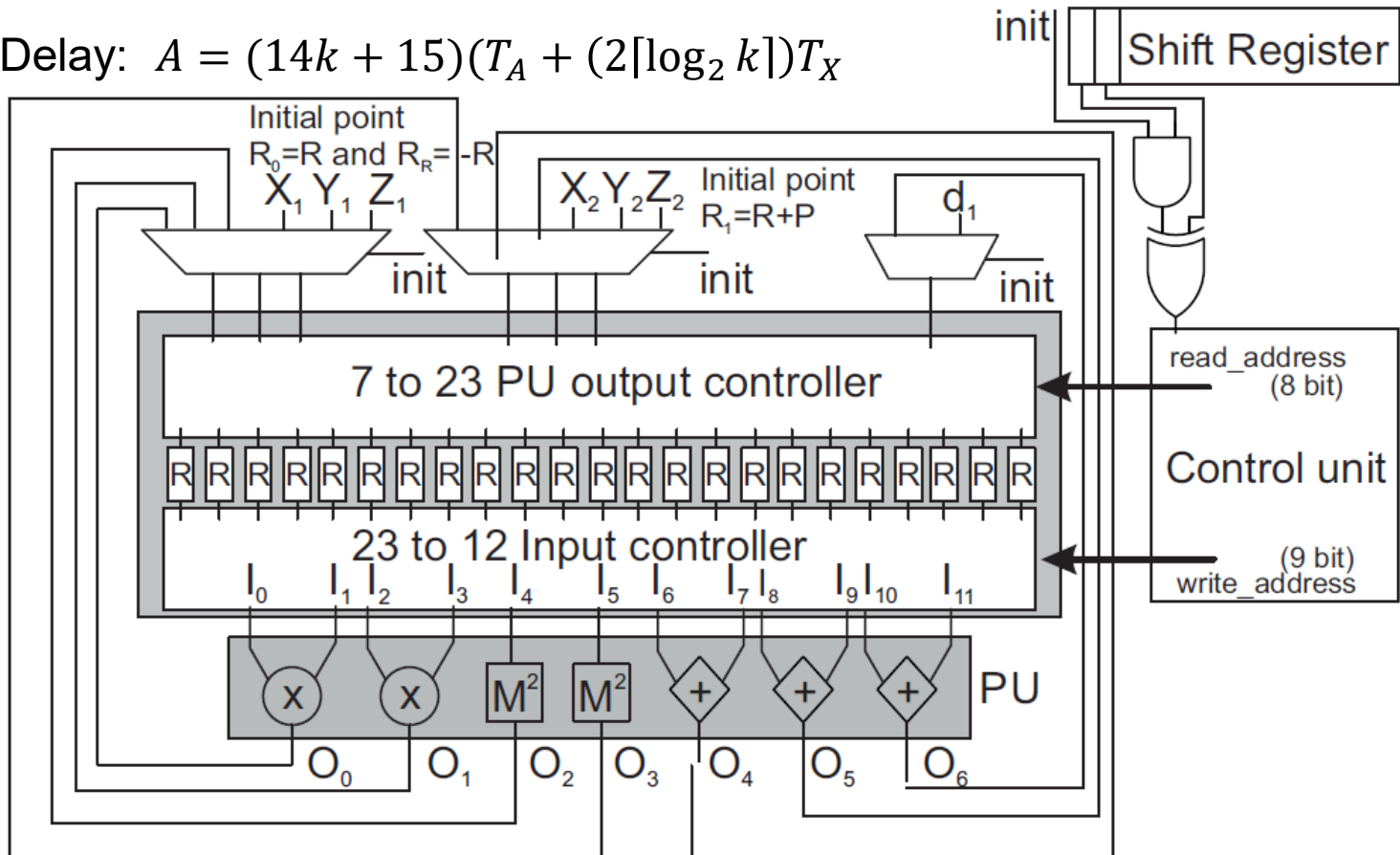
\* : dummy operation

Each layer needs 1 clock cycle to come up with a result.

clock cycle time period dictated by the GF(2<sup>k</sup>) multiplier

# PROPOSED BEC SCALAR MULTIPLIER ARCHITECTURE

Total Delay:  $A = (14k + 15)(T_A + (2\lceil \log_2 k \rceil)T_X)$



Multiplier unit: bit parallel Karatsuba-Ofman based on

H. Fan, J. Sun, M. Gu, and K.-Y. Lam, "Overlap-free Karatsuba-Ofman polynomial multiplication algorithms," *IET Information Security*, vol. 4, no. 1, p. 8, 2010.

# BEC SCALAR MULTIPLIER IMPLEMENTATION RESULTS-COMPARISONS

arch.	techn.	k	Area	max Freq.	time delay	effic.	SCA resist.	
prop.	XC5VLX110	233	32874	132	0.025	0.81	Point Rand	BEC
prop.	XC4VFX140	233	40793	67	0.049	1.97	Point Rand	BEC
[11]	XC4V140	233	35003	47	0.19	6.65	intrinsic SPA	BEC
[29]	XC5VLX110	233	18097	156	0.012	0.2	No	WS
[3]	XC5VLX110	163	17305	262	0.013	0.22	intrinsic SPA	BEC
[3]	XC5VLX110	233	~25000	~200	~0.025	0.6	Intrinsic SPA	

Prop. in Xilinx Virtex 4 better than BEC [11] (faster + better SCA resistance)

Prop. In Xilinx Virtex 5 same speed as normalized BEC [2] but worst Area (note that very rough estimations are made) but offers better SCA resistance.

Prop. In Xilinx Virtex 5 speed close to Weierstrass ECs of [29]. Still more optimizations are needed but [29] results achieved with no SPA/SCA resistance.

# CONCLUSIONS — FUTURE WORK

Come close to Weierstrass ECs scalar multiplier performance through parallelism and increasing the number of parallel components (2  $\text{GF}(2^k)$  multipliers instead of 1).

## ***Future Work:***

- Explore more compact multipliers to save chip covered areas like hybrid or digit serial multipliers
- Explore Different, less costly randomization approaches exploiting BEC intrinsic resistance (randomized projective coordinates??)

# QUESTIONS?

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End of Presentation  
Thank You!